

HA-4902/883

T-73-53

January 1989

Precision Quad Comparator

Features

- This Circuit is Processed in Accordance to MIL-Std-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- Fast Response Time (+25°C) 215ns (Max)
180ns (Typ)
- Low Offset Voltage (+25°C) 5mV (Max)
2mV (Typ)
- Low Input Sensitivity 0.5mV (Max)
0.05mV (Typ)
- Low Offset Current (+25°C) 35nA (Max)
10nA (Typ)
- Single or Dual-Voltage Supply Operation
- Selectable Output Logic Levels
- Active Pull-Up/Pull-Down Output Circuit — No External Resistors Required

Applications

- Threshold Detector
- Zero-Crossing Detector
- Window Detector
- Analog Interfaces for Microprocessors
- High Stability Oscillators
- Logic System Interface

Description

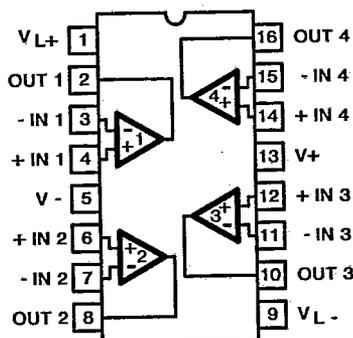
The HA-4902/883 is a monolithic, quad, precision comparator offering fast response time, low offset voltage, low offset current, and virtually no channel-to-channel crosstalk for applications requiring accurate, high speed, signal level detection. This comparator can sense signals at ground level while being operated from either single +5V supply (digital systems) or from dual supplies (analog networks) up to ±15V. The HA-4902/883 contains a unique current driven output stage which can be connected to logic system supplies (V_{LOGIC+} and V_{LOGIC-}) to make the output levels directly compatible (no external components needed) with any standard logic or special system logic levels. In combination analog/digital systems, the design employed in the HA-4902/883 input and output stages prevents troublesome ground coupling of signals between analog and digital portions of the system.

This comparator's combination of features makes it an ideal component for signal detection and processing in data acquisition systems, test equipment, and microprocessor/analog signal interface network.

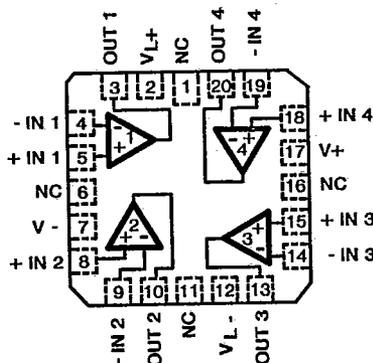
The HA-4902/883 is available in a 16 pin Ceramic DIP package and in a 20 pin Ceramic LCC package and is specified over the military, -55°C to +125°C, temperature range.

Pinouts

HA1-4902/883 (CERAMIC DIP)
TOP VIEW



HA4-4902/883 (CERAMIC LCC)
TOP VIEW



Absolute Maximum Ratings

Voltage Between V+ and V- Terminals 33V
 Differential Input Voltage ±15V
 Peak Output Current ±50mA
 Output Short Circuit Current Duration Indefinite
 (One Amplifier Shorted to GND)
 Junction Temperature +175°C
 Storage Temperature Range -65°C to +150°C
 ESD Rating < 2000V
 Lead Temperature (Soldering 10 sec) +275°C

CAUTION: Absolute maximum ratings are limiting values, applied individually beyond which the serviceability of the circuit may be impaired. Functional operability under any of these conditions is not necessarily implied.

Thermal Information

Thermal Resistance θ_{ja} θ_{jc}
 Ceramic DIP Package 76°C/W 17°C/W
 Ceramic LCC Package 78°C/W 19°C/W
 Package Power Dissipation at +75°C
 Ceramic DIP Package 1.31W
 Ceramic LCC Package 1.32W
 Package Power Dissipation Derating Factor Above +75°C
 Ceramic DIP Package 13.1mW/°C
 Ceramic LCC Package 13.1mW/°C

Recommended Operating Conditions

Operating Temperature Range -55°C to +125°C Logic Supply Voltage (V_{L+}) +5V
 Operating Supply Voltage ±15V Logic Reference Voltage (V_{L-}) 0V

TABLE 1. D.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Tested at: Supply Voltage = ±15V, V_L = 0V, Unless Otherwise Specified.

| D.C. PARAMETERS | SYMBOL | CONDITIONS | GROUP A SUBGROUP | TEMPERATURE | LIMITS | | UNITS |
|-----------------------|---------------------|---|------------------|---------------|--------|-----|-------|
| | | | | | MIN | MAX | |
| Input Offset Voltage | V _{IO} | V _{CM} = 0V, V _{OUT} = 1.4V See Note 3 | 1 | +25°C | -5 | 5 | mV |
| | | | 2,3 | +125°C, -55°C | -8 | 8 | mV |
| Input Bias Current | +I _B | V _{CM} = 0V | 1 | +25°C | -150 | 150 | nA |
| | | | 2,3 | +125°C, -55°C | -200 | 200 | nA |
| | -I _B | V _{CM} = 0V | 1 | +25°C | -150 | 150 | nA |
| | | | 2,3 | +125°C, -55°C | -200 | 200 | nA |
| Input Offset Current | I _{IO} | V _{CM} = 0V | 1 | +25°C | -35 | 35 | nA |
| | | | 2,3 | +125°C, -55°C | -45 | 45 | nA |
| Input Sensitivity | I _{SEN} | See Note 3 | 1 | +25°C | -0.5 | 0.5 | mV |
| | | | 2,3 | +125°C, -55°C | -0.6 | 0.6 | mV |
| Output Voltage Levels | V _{OL} | I _{SINK} = 3mA | 1 | +25°C | - | 0.4 | V |
| | | | 2,3 | +125°C, -55°C | - | 0.4 | V |
| | V _{OH} | I _{SOURCE} = 3mA | 1 | +25°C | 3.5 | - | V |
| | | | 2,3 | +125°C, -55°C | 3.5 | - | V |
| Output Current | I _{SINK} | V _{OUT} ≤ 0.4V | 1 | +25°C | 3 | - | mA |
| | | | 2,3 | +125°C, -55°C | 3 | - | mA |
| | I _{SOURCE} | V _{OUT} ≥ 3.5V | 1 | +25°C | - | -3 | mA |
| | | | 2,3 | +125°C, -55°C | - | -3 | mA |
| Supply Current | +I _{CC} | V _{OUT} = V _{OL} , V _{OH} | 1 | +25°C | - | 20 | mA |
| | | | 2,3 | +125°C, -55°C | - | 20 | mA |
| | -I _{CC} | V _{OUT} = V _{OL} , V _{OH} | 1 | +25°C | - | 8 | mA |
| | | | 2,3 | +125°C, -55°C | - | 10 | mA |
| Logic Current | I _L | V _{OUT} = V _{OL} , V _{OH} | 1 | +25°C | - | 6 | mA |
| | | | 2,3 | +125°C, -55°C | - | 8 | mA |

CAUTION: This device is sensitive to electrostatic discharge. Proper I.C. handling procedures should be followed.

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TABLE 2. A.C. ELECTRICAL PERFORMANCE CHARACTERISTICS

Table 2 Intentionally Left Blank. See A.C. Specifications on Table 3.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

Device Characterized at: Supply Voltage = ±15V, V_L = GND, Unless Otherwise Specified.

| PARAMETERS | SYMBOL | CONDITIONS | NOTES | TEMPERATURE | LIMITS | | UNITS |
|-------------------|------------------|------------------------------------|-------|-------------|--------|------|-------|
| | | | | | MIN. | MAX. | |
| Response Time | t _{pd0} | +100mV Input Step, 10mV Overdrive | 1, 2 | +25°C | - | 200 | ns |
| | t _{pd1} | -100mV Input Step, -10mV Overdrive | 1, 2 | +25°C | - | 215 | ns |
| Common Mode Range | +CMR | | 1 | +25°C | - | 12.4 | V |
| | -CMR | | 1 | +25°C | -15 | - | V |

NOTES: 1. Parameters listed in Table 3 are controlled via design or process parameters and are not directly tested at final production. These parameters are lab characterized upon initial design release, or upon design changes. These parameters are guaranteed by characterization based upon data from multiple production runs which reflect lot to lot and within lot variation.

2. F ≈ 100Hz, duty cycle ≈ 50%, inverting input driven, all unused inverting inputs tie to +5V.

3. Refer to enlarged area of test waveform A. Offset voltage is measured when V_{OUT} = 1.4V. Sensitivity is measured on the transition edge at 0.4V and 3.5V. Sensitivity is the change in differential input voltage required to change the output state. Sensitivity includes the effects of offset voltage, offset current, common mode rejection and voltage gain.

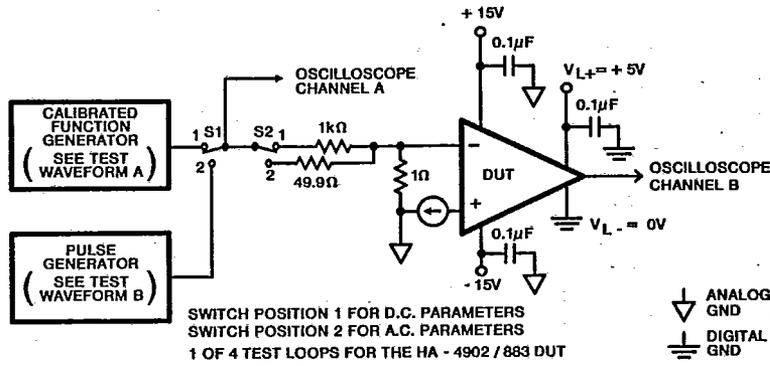
TABLE 4. ELECTRICAL TEST REQUIREMENTS

| MIL-STD-883 TEST REQUIREMENTS | SUBGROUPS (SEE TABLES 1 & 2) |
|---|------------------------------|
| Interim Electrical Parameters (Pre Burn-In) | 1 |
| Final Electrical Test Parameters | 1*, 2, 3 |
| Group A Test Requirements | 1, 2, 3 |
| Groups C & D Endpoints | 1 |

* PDA applies to Subgroup 1 only.

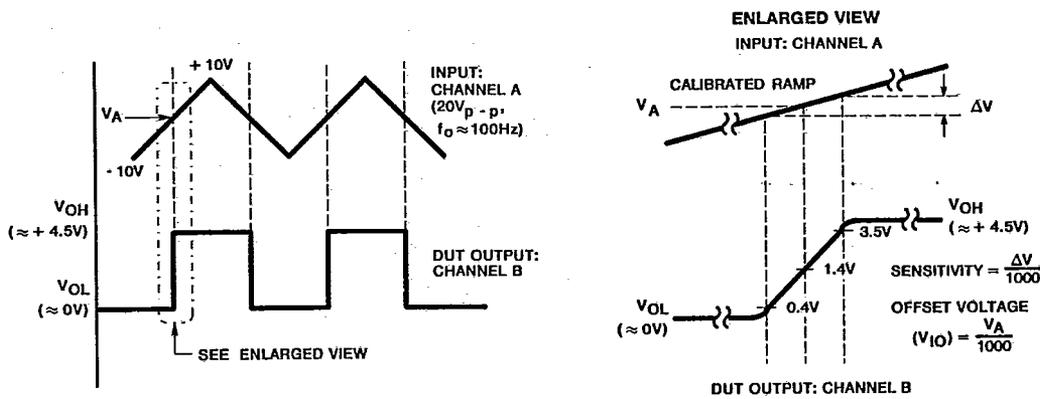
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Test Circuit (Applies to Tables 1 and 3)

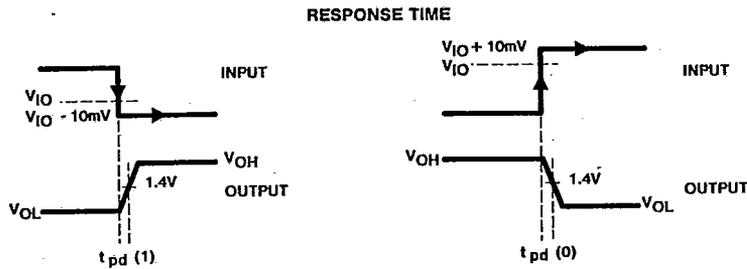


For Detailed Information, Refer to HA-4902/883 Test Tech Brief

Test Waveform A (Applies to Table 1)



Test Waveform B (Applies to Table 3)

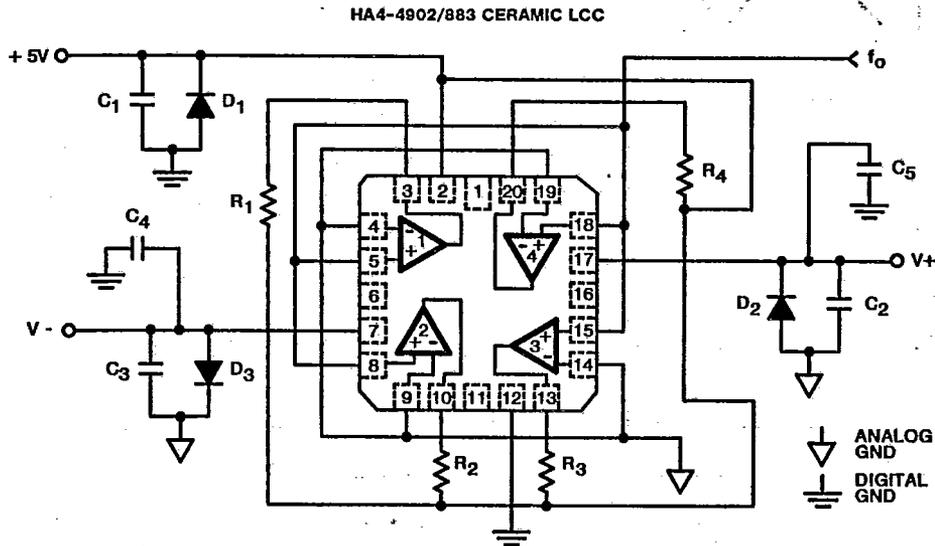
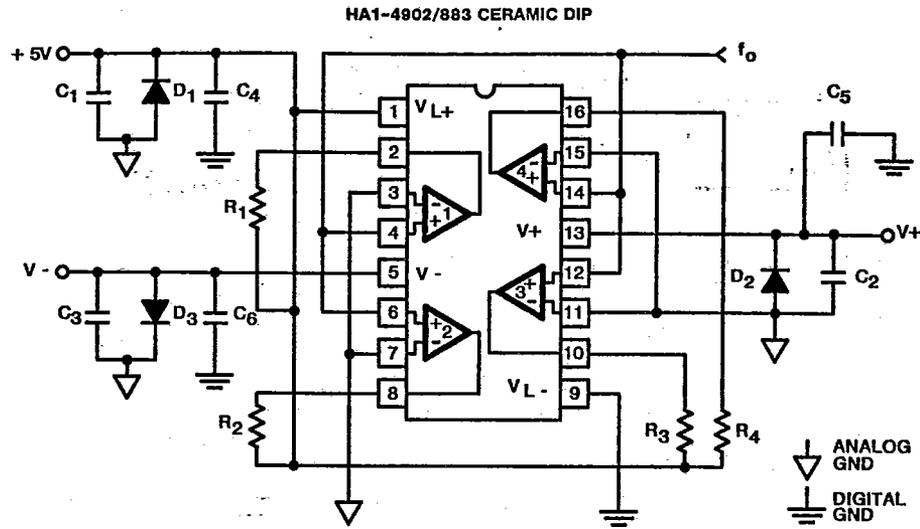


NOTE: Response time testing is done after V_{IO} testing to acquire the actual device offset voltage. 10mV overdrive is then added (or subtracted depending on state) to this measured V_{IO} value.

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Burn-In Circuits



NOTES:

- R₁ = 5kΩ, ±5%
- C₁ = C₂ = C₃ = 0.01μF/Socket (Min) or 0.1μF/Row (Min)
- C₄ = C₅ = C₆ = 0.01μF/Socket (Min) or 0.1μF/Row (Min)
- D₁ = D₂ = D₃ = IN4002 or Equivalent/Board
- |V₊ - V₋| = 30V
- V_{L-} = 0V, V_{L+} = 5V
- f₀ = 5V (Static Burn-in)

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Die Characteristics

DIE DIMENSIONS:

95 x 105 x 19 mils
(2420 x 2670 x 483 μm)

METALLIZATION:

Type: Aluminum
Thickness: 16kÅ ± 2kÅ

WORST CASE CURRENT DENSITY:

0.4 x 10⁹A/cm²

SUBSTRATE POTENTIAL (Powered Up): V-

GLASSIVATION:

Type: Nitride
Thickness: 7kÅ ± 0.7kÅ

TRANSISTOR COUNT: 137

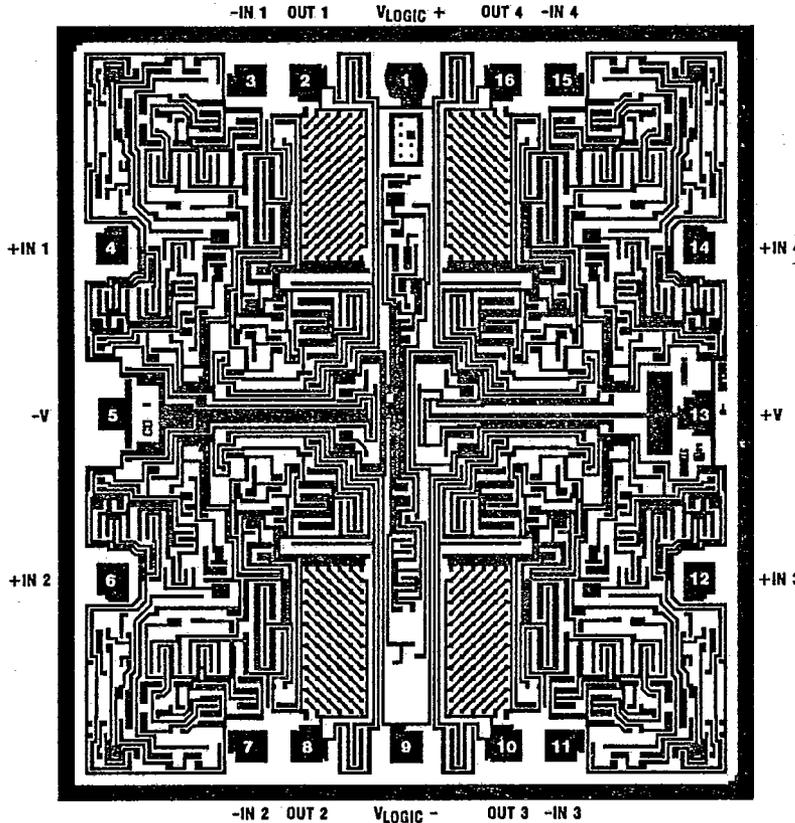
PROCESS: Combination of Std. Linear and MOS Dielectric Isolation

DIE ATTACH:

Material: Gold/Silicon Eutectic Alloy
Temperature: Ceramic DIP — 460°C (Max)
Ceramic LCC — 420°C (Max)

Metallization Mask Layout

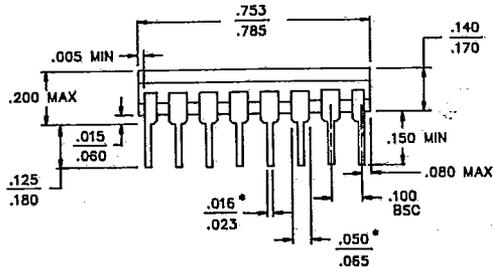
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NOTE: Bond Pad Numbers Correspond to 16 Pin Ceramic DIP Only.

Packaging†

16 PIN CERAMIC DIP

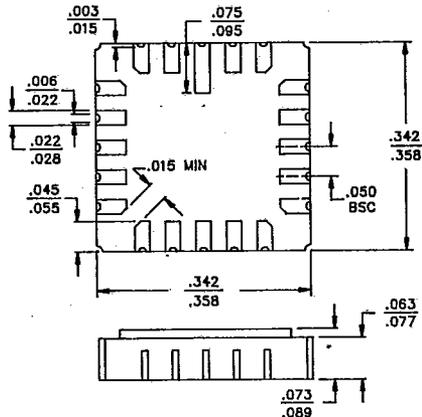


• INCREASE MAX LIMIT BY .003 INCHES MEASURED AT CENTER OF FLAT FOR SOLDER FINISH

LEAD MATERIAL: Type B
LEAD FINISH: Type A
PACKAGE MATERIAL: Ceramic, 90% Alumina
PACKAGE SEAL:
 Material: Glass Frit
 Temperature: 450°C ± 10°C
 Method: Furnace Seal

INTERNAL LEAD WIRE:
 Material: Aluminum
 Diameter: 1.25 Mil
 Bonding Method: Ultrasonic
COMPLIANT OUTLINE: 38510 D-2

20 PAD CERAMIC LCC



PAD MATERIAL: Type C
PAD FINISH: Type A
FINISH DIMENSION: Type A
PACKAGE MATERIAL: Multilayer Ceramic, 90% Alumina
PACKAGE SEAL:
 Material: Gold/TIn (80/20)
 Temperature: 320°C ± 10°C
 Method: Furnace Braze

INTERNAL LEAD WIRE:
 Material: Aluminum
 Diameter: 1.25 Mil
 Bonding Method: Ultrasonic
COMPLIANT OUTLINE: 38510 C-2

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NOTE: All Dimensions are $\frac{\text{Min}}{\text{Max}}$ Dimensions are in inches.

†Mil-M-38510 Compliant Materials, Finishes, and Dimensions.



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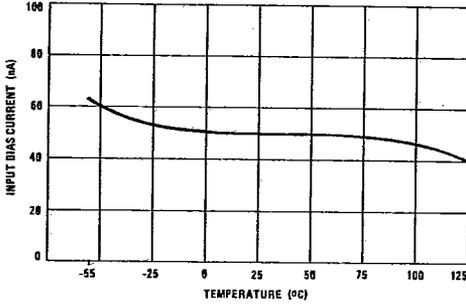
Precision Quad Comparator

DESIGN INFORMATION

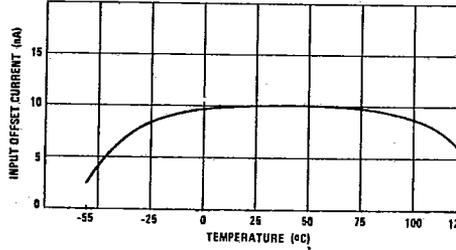
The information contained in this section has been developed through characterization by Harris Semiconductor and is for use as application and design aid only. These characteristics are not 100% tested and no product guarantee is implied.

Typical Performance Curves Unless Otherwise Specified: $T_A = +25^\circ\text{C}$, $V_{\text{SUPPLY}} = \pm 15\text{V}$, $V_{\text{LOGIC}+} = 5\text{V}$, $V_{\text{LOGIC}-} = 0\text{V}$

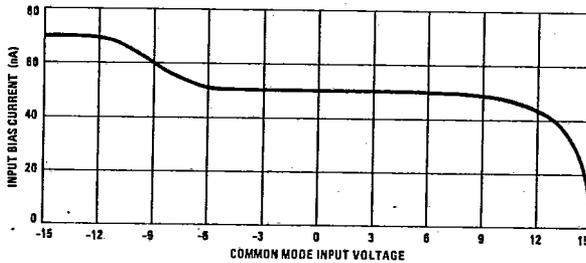
INPUT BIAS CURRENT vs. TEMPERATURE



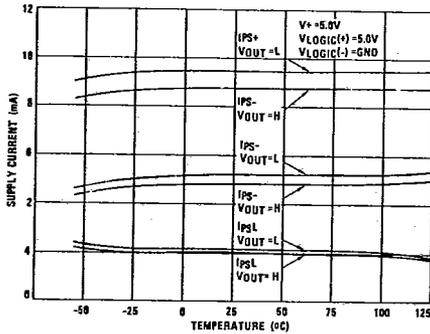
INPUT OFFSET CURRENT vs. TEMPERATURE



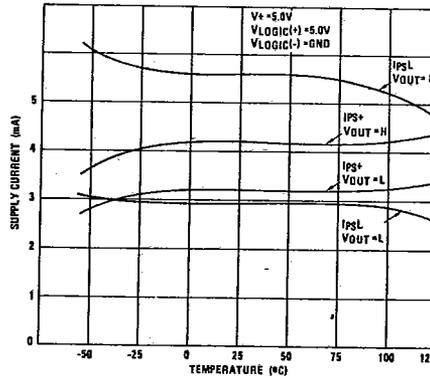
INPUT BIAS CURRENT vs. COMMON MODE INPUT VOLTAGE ($V_{\text{DIFF}} = 0\text{V}$)



SUPPLY CURRENT vs. TEMPERATURE FOR $\pm 15\text{V}$ SUPPLIES AND $+5\text{V}$ LOGIC SUPPLY



SUPPLY CURRENT vs. TEMPERATURE FOR SINGLE $+5\text{V}$ OPERATION



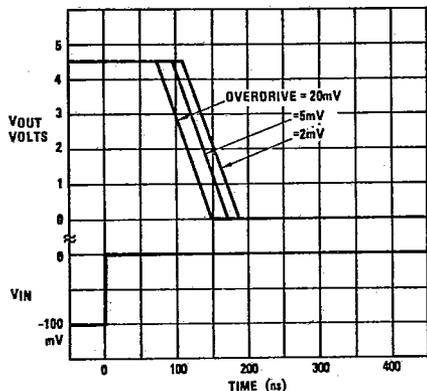
DESIGN INFORMATION (Continued)

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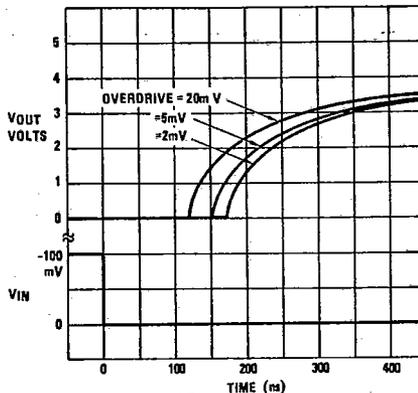
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Typical Performance Curves Unless Otherwise Specified: $T_A = +25^\circ\text{C}$, $V_{\text{SUPPLY}} = \pm 15\text{V}$
 $V_{\text{LOGIC}+} = 5\text{V}$, $V_{\text{LOGIC}-} = 0\text{V}$

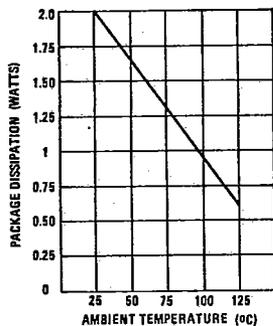
RESPONSE TIME FOR VARIOUS INPUT OVERDRIVES



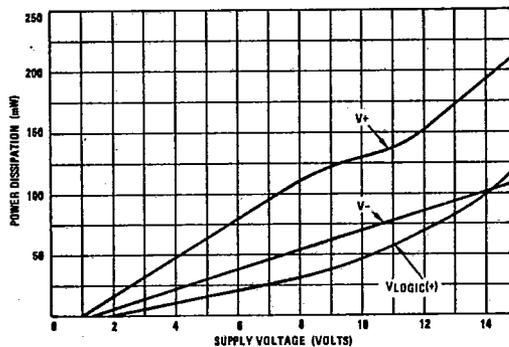
RESPONSE TIME FOR VARIOUS INPUT OVERDRIVES



MAXIMUM PACKAGE DISSIPATION vs. AMBIENT



MAXIMUM POWER DISSIPATION vs. SUPPLY VOLTAGE (No Load Condition)



NOTE: Total Power Dissipation (TPD) is the sum of individual dissipation contributions of V_+ , V_- and V_{LOGIC} shown in curves of Power Dissipation vs. Supply Voltages. The calculated TPD is then located on the graph of Maximum Allowable Package Dissipation vs. Ambient Temperature to determine ambient temperature operating limits imposed by the calculated TPD (See Performance Curves). For instance, the combination of $\pm 15\text{V}$, 5V , 0V ($\pm V$, $V_{\text{LOGIC}+}$, $V_{\text{LOGIC}-}$) gives a TPD of 350mW , the combination $\pm 15\text{V}$, 0V gives a TPD of 450mW .

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DESIGN INFORMATION (Continued)

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TYPICAL PERFORMANCE CHARACTERISTICS

Device Characterized at: Supply Voltage = $\pm 15V$, $V_{L+} = 5V$, $V_{L-} = 0V$, Unless Otherwise Specified.

| PARAMETERS | CONDITIONS | TEMP | TYPICAL | DESIGN LIMIT | UNITS |
|----------------------|----------------------------|-------|---------|--------------|---------|
| Offset Voltage | Note 3 | Full | 0.5 | Table 1 | mV |
| Input Bias Current | | +25°C | 50 | Table 1 | nA |
| | | Full | 90 | Table 1 | nA |
| Input Offset Current | | +25°C | 10 | Table 1 | nA |
| | | Full | 20 | Table 1 | nA |
| Input Sensitivity | Note 3 | Full | 50 | Table 1 | μV |
| Output Level | $V_{OL}; I_{SINK} = 3mA$ | Full | 0.15 | Table 1 | V |
| | $V_{OH}; I_{SOURCE} = 3mA$ | Full | 4.3 | Table 1 | V |
| Supply Current | +CC; $V_{OUT} = V_{OH}$ | Full | 10 | Table 1 | mA |
| | +CC; $V_{OUT} = V_{OL}$ | Full | 15 | Table 1 | mA |
| | -CC; $V_{OUT} = V_{OH}$ | Full | -6 | Table 1 | mA |
| | -CC; $V_{OUT} = V_{OL}$ | Full | -8 | Table 1 | mA |
| Logic Current | $I_L; V_{OUT} = V_{OH}$ | Full | 2 | Table 1 | mA |
| | $I_L; V_{OUT} = V_{OL}$ | Full | 4 | Table 1 | mA |
| Response Time | t_{pd0} | Full | 150 | Table 3 | ns |
| | t_{pd1} | Full | 150 | Table 3 | ns |

Applying The HA-4902 Comparator

Supply Connections

This device is exceptionally versatile in working with most available power supplies. The voltage applied to the V_+ and V_- terminals determines the allowable input signal range, while the voltage applied to the V_{L+} and V_{L-} determines the output swing. In systems where dual analog supplies are available, these would be connected to V_+ and V_- , while the logic supply and return would be connected to V_{LOGIC+} and V_{LOGIC-} . The analog and logic supply commons can be connected together at one point in the system, since the comparator is immune to noise on the logic supply ground. A negative output swing may be obtained by connecting V_{L+} to ground and V_{L-} to a negative supply. Bipolar output swings ($15V_{p-p}$, max.) may be obtained using dual supplies. In systems where only a single logic supply is available (+5V to +15V), V_+ and V_{LOGIC+} may be connected together to the positive supply while V_- and V_{LOGIC-} are grounded. If an input signal could swing negative with respect to the V_- terminal, a resistor should be connected in series with the input to limit input current to $< 5mA$ since the C-B junction of the input transistor would be forward biased.

Unused Inputs

Inputs of unused comparator sections should be tied to a differential voltage source to prevent output "chatter"

($V_{DIFF} \geq V_{IO}$). All unused inverting inputs may be tied to +5V and non-inverting inputs tied to ground.

Crosstalk

Simultaneous high frequency operation of all other channels in the package will not affect the output logic state of a given channel, provided that its differential input voltage is sufficient to define a given logic state ($\Delta V_{IN} \geq \pm V_{IO}$). Low level or high impedance input lines should be shielded from other signal sources to reduce crosstalk and interference.

Power Supply Decoupling

Decouple all power supply lines with $0.01\mu F$ ceramic capacitors to a ground line located near the package to reduce coupling between channels or from external sources.

Response Time

Fast rise time ($< 200ns$) input pulses of several volts amplitude may result in delay times somewhat longer than those illustrated for 100mV steps. Operating speed is optimized by limiting the maximum differential input voltage applied, with resistor-diode clamping networks.